## Linear IC Converter

## CMOS

## D/A Converter for Digital Tuning (12-channel, 8-bit, on-chip OP amp, low-voltage) MB88346L

## DESCRIPTION

The Fujitsu Microelectronics MB88346L is a 12-channel 8-bit D/A converter capable of low-voltage operation that has amplifiers built into each of the 12 analog output lines to deliver heavy-current drive capability.
The use of serial data input means that only three control lines are required, and enables cascade connection of multiple MB88346L chips.
The MB88346L is suitable for applications such as electronic volume controls and replacing trimmer potentiometers in tuning systems. In addition, the MB88346L is both function-compatible and pin-compatible the currently used MB88346B, making it easy to reduce the voltage level of a system by simply replacing the MB88346B with the MB88346L.

## ■ FEATURES

- Low voltage operation ( $\mathrm{V}_{\mathrm{cc}} / \mathrm{V}_{\mathrm{DD}}$ : 2.7 V to 3.6 V )
- Ultra-low power consumption ( $0.5 \mathrm{~mW} / \mathrm{ch}$ at $\mathrm{V} \mathrm{cc}=3 \mathrm{~V}$ )
- Ultra-compact space-saving package lineup (SSOP-20)
- Contains 12 -channel R-2R type 8 -bit D/A converter
- On-chip analog output amps (sink current max. 1.0 mA , source current max. 1.0 mA )
- Analog output range from 0 to $\mathrm{V}_{\mathrm{cc}}$
- Two separate power supply/ground lines for MCU interface block/operational amplifier output buffer block and D/A converter block
- Serial data input : maximum operating speed 2.5 MHz
(maximum operating speed in cascade connection is 1.5 MHz )
- CMOS process
- Package lineup includes DIP 20-pin, SSOP 20-pin


## MB88346L

## PIN ASSIGNMENT

(Top view)

(DIP-20P-M02)
(FPT-20P-M03)

## PIN DESCRIPTION

| Pin No. | Symbol | I/O | Function |
| :---: | :---: | :---: | :--- |
| 17 | DI | I | Serial address/data input to the internal 12-bit shift register : The ad- <br> dress/data format is that upper 4 bits (D11 to D8) indicate an address <br> and lower 8 bits (D7 to D0) indicate data. The D11 (MSB) is the first- <br> in bit and D0 (LSB) is the last-in bit. |
| 14 | DO | O | Outputs MSB bit data from 12-bit shift register. |
| 16 | CLK | I | Shift clock input to the internal 12-bit shift register : At the rising edge <br> of CLK data on the DI pin is shifted into the LSB of the shift register <br> and contents of the shift register are shifted right (to the MSB) . |
|  |  |  | Load strobe input for a 12-bit address/data : A high level on the LD pin <br> latches a 4-bit address (upper 4 bits : D11 to D8) of the internal 12-bit |
| shift register into the internal address decoder, and writes 8-bit data |  |  |  |
| (lower 8 bits : D7 to D0) of the shift register into an internal data latch |  |  |  |
| selected by the latched address. |  |  |  |

## MB88346L

## BLOCK DIAGRAM



## MB88346L

## - DATA CONFIGURATION

The MB88346L has a 12-bit shift register for controlling the chip. The data passed to the 12-bit shift register needs to be supplied in the following format.
The data structure consists of a total of 12 bits, four for address selection and eight for D/A data output.

## 1. Shift Register Control Data Configuration


2. D/A Converter Control Signals

| D0 | D1 | D2 | D3 | D4 | D5 | D6 | D7 | D/A data output |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :--- |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | $\doteqdot \mathrm{~V}_{\mathrm{Ss}}$ |
| 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | $\doteqdot \mathrm{~V}_{\mathrm{LB}}+\mathrm{V}_{\mathrm{Ss}}$ |
| 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | $\doteqdot \mathrm{~V}_{\mathrm{LB}} \times 2+\mathrm{V}_{\mathrm{SS}}$ |
| $\vdots$ | $\vdots$ | $\vdots$ | $\vdots$ | $\vdots$ | $\vdots$ | $\vdots$ | $\vdots$ | $\vdots$ |
| 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | $\doteqdot \mathrm{~V}_{\mathrm{LB}} \times 254+\mathrm{V}_{\mathrm{SS}}$ |
| 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | $\doteqdot \mathrm{~V}_{\mathrm{DD}}$ |

## MB88346L

3. Address Selection Signals

| D8 | D9 | D10 | D11 | Address selection |
| :---: | :---: | :---: | :---: | :--- |
| 0 | 0 | 0 | 0 | Don't Care |
| 0 | 0 | 0 | 1 | $\mathrm{AO}_{1}$ selection |
| 0 | 0 | 1 | 0 | $\mathrm{AO}_{2}$ selection |
| 0 | 0 | 1 | 1 | $\mathrm{AO}_{3}$ selection |
| 0 | 1 | 0 | 0 | $\mathrm{AO}_{4}$ selection |
| 0 | 1 | 0 | 1 | $\mathrm{AO}_{5}$ selection |
| 0 | 1 | 1 | 0 | $\mathrm{AO}_{6}$ selection |
| 0 | 1 | 1 | 1 | $\mathrm{AO}_{7}$ selection |
| 1 | 0 | 0 | 0 | $\mathrm{AO}_{8}$ selection |
| 1 | 0 | 0 | 1 | $\mathrm{AO}_{9}$ selection |
| 1 | 0 | 1 | 0 | $\mathrm{AO}_{10}$ selection |
| 1 | 0 | 1 | 1 | $\mathrm{AO}_{11}$ selection |
| 1 | 1 | 0 | 0 | $\mathrm{AO}_{12}$ selection |
| 1 | 1 | 0 | 1 | $\mathrm{Don't}^{\prime}$ Care |
| 1 | 1 | 1 | 0 | Don't Care |
| 1 | 1 | 1 | 1 | Don't Care |

## OPERATING DESCRIPTION

## 1. Timing Chart for Data Condition Setup


2. Analog Output Voltage Range


## ABSOLUTE MAXIMUM RATINGS

| Parameter | Symbol | Condition | Rating |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Max |  |
| Power supply voltage | Vcc | GND used as reference,$\mathrm{Ta}=+25^{\circ} \mathrm{C}$ | -0.3 | + 7.0 | V |
|  | VDo* |  | -0.3 | + 7.0 | V |
| Input voltage | VIN |  | -0.3 | $\mathrm{V} \mathrm{cc}+0.3$ | V |
| Output voltage | Vout |  | -0.3 | $\mathrm{V} \mathrm{cc}+0.3$ | V |
| Power consumption | PD | - | - | 250 | mW |
| Operating temperature | Ta | - | -20 | + 85 | ${ }^{\circ} \mathrm{C}$ |
| Storage temperature | Tstg | - | -55 | + 150 | ${ }^{\circ} \mathrm{C}$ |

* $: V_{c c} \geq V_{D D}$

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

## ■ RECOMMENDED OPERATING CONDITIONS

| Parameter | Symbol | Condition | Value |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max |  |
| Power supply voltage 1 | Vcc | - | 2.7 | - | 3.6 | V |
|  | GND | - | - | 0 | - | V |
| Power supply voltage 2 | V ${ }_{\text {d }}$ | VDD - Vss $\geq 2.0 \mathrm{~V}$ | 2.0 | - | Vcc | V |
|  | Vss |  | GND | - | Vcc-2.0 | V |
| Analog output source current | IAL | $\mathrm{V} \mathrm{cc}=3.0 \mathrm{~V}$ | - | - | 1.0 | mA |
| Analog output sink current | ІАн | $\mathrm{Vcc}=3.0 \mathrm{~V}$ | - | - | 1.0 | mA |
| Oscillator limiting output capacity | Cal | - | - | - | 0.1 | $\mu \mathrm{F}$ |
| Digital data value range | - | - | \#00 | - | \#FF | - |
| Operating temperature | Ta | - | - 20 | - | + 85 | ${ }^{\circ} \mathrm{C}$ |

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.
Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.
No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their representatives beforehand.

## - ELECTRICAL CHARACTERISTICS

## 1. DC Characteristics

(1) Digital Block
$\left(\mathrm{V}_{\mathrm{DD}}, \mathrm{V}_{\mathrm{cc}}=2.7 \mathrm{~V}\right.$ to $3.6 \mathrm{~V}(\mathrm{~V} \mathrm{Cc} \geq \mathrm{V} \mathrm{DD}), \mathrm{GND}=\mathrm{V}_{\mathrm{ss}}=0 \mathrm{~V}, \mathrm{Ta}=-20^{\circ} \mathrm{C}$ to $\left.+85^{\circ} \mathrm{C}\right)$

| Parameter | Symbol | Pin | Condition | Value |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max |  |
| Power supply voltage | Vcc | Vcc | - | 2.7 | 3.0 | 3.6 | V |
| Power supply current 1 | Icc |  | Stationary (CLK signal stopped), no load | - | 1.2 | 3.0 | mA |
| Input leak current | Іıк | $\underset{\text { LD }}{\text { CLK, }}$ | Viv $=0$ to Vcc | - 10 | - | + 10 | $\mu \mathrm{A}$ |
| L level input voltage | VIL |  | - | - | - | 0.2 Vcc | V |
| H level input voltage | $\mathrm{V}_{\mathrm{H}}$ |  | - | 0.8 Vcc | - | - | V |
| L level output voltage | VoL | DO | $\mathrm{loL}=2.5 \mathrm{~mA}$ | - | - | 0.4 | V |
| H level output voltage | Vor |  | $\mathrm{IOH}=-400 \mu \mathrm{~A}$ | V $\mathrm{cc}-0.4$ | - | - | V |

(2) Analog Block 1
( $\mathrm{V}_{\mathrm{DD},} \mathrm{V}_{\mathrm{Cc}}=2.7 \mathrm{~V}$ to $3.6 \mathrm{~V}(\mathrm{~V} \mathrm{Cc} \geq \mathrm{V} \mathrm{D}), \mathrm{GND}=\mathrm{V}_{\mathrm{s}}=0 \mathrm{~V}, \mathrm{Ta}=-20^{\circ} \mathrm{C}$ to $\left.+85^{\circ} \mathrm{C}\right)$

| Parameter | Symbol | Pin | Condition | Value |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max |  |
| Power consumption | Iod | VDD | Maximum setting value from \#00 to \#FF | - | 0.6 | 1.5 | mA |
| Analog voltage | Vdo | VDD | $V_{\text {do }}-V_{s s} \geq 2.0$ | 2.0 | - | Vcc | V |
|  | Vss | Vss |  | GND | - | V cc - 2.0 | V |
| Resolution | Res | $\mathrm{AO}_{1}$ to $\mathrm{AO}_{12}$ | - | - | 8 | - | bit |
| Monotonic increase | Rem |  | $\begin{aligned} & V_{\mathrm{DD}} \leq \mathrm{V}_{\mathrm{cc}}-0.1 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{ss}} \geq 0.1 \mathrm{~V}, \text { no load } \end{aligned}$ | - | 8 | - | bit |
| Nonlinearity error | LE |  |  | -1.5 | - | + 1.5 | LSB |
| Differential linearity error | DLE |  |  | -1.0 | - | +1.0 | LSB |

Nonlinearity error: Deviation (error) in input/output curves with respect to an ideal straight line connecting output voltage at " 00 " and output voltage at "FF."
Differential linearity error : Deviation (error) in amplification with respect to theoretical increase in amplification per 1-bit increase in digital value.


Note: The value of $V_{\text {AOH }}$ and $V_{D D}$, and the value of $V_{A O L}$ and $V_{s s}$ are not necessarily equivalent.

## MB88346L

(3) Analog Block 2
$\left(\mathrm{V}_{\mathrm{dd}}, \mathrm{V}_{\mathrm{cc}}=2.7 \mathrm{~V}\right.$ to $3.6 \mathrm{~V}\left(\mathrm{~V}_{\mathrm{cc}} \geq \mathrm{V} \mathrm{Dd}\right), \mathrm{GND}=\mathrm{V} \mathrm{ss}=0 \mathrm{~V}, \mathrm{Ta}=-20^{\circ} \mathrm{C}$ to $\left.+85^{\circ} \mathrm{C}\right)$

| Parameter | Symbol | Pin | Condition | Value |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max |  |
| Output minimum voltage 1 | $\mathrm{V}_{\text {AOL1 }}$ | $\mathrm{AO}_{1}$ to $\mathrm{AO}_{12}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=\mathrm{V} \mathrm{VC}=3.0 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{SS}}=\mathrm{GND}=0.0 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{AL}}=0 \mu \mathrm{~A} \\ & \text { Digital data }=\# 00 \end{aligned}$ | Vss | - | Vss +0.1 | V |
| Output minimum voltage 2 | $V_{\text {Aol2 }}$ |  | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=\mathrm{V} \mathrm{VC}=3.0 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{SS}}=\mathrm{GND}=0.0 \mathrm{~V}, \\ & \mathrm{IAL}^{\mathrm{AL}}=500 \mu \mathrm{~A} \\ & \text { Digital data }=\# 00 \end{aligned}$ | Vss - 0.2 | Vss | Vss +0.2 | V |
| Output minimum voltage 3 | $V_{\text {AOL3 }}$ |  | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=\mathrm{V} \mathrm{VC}=3.0 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{SS}}=\mathrm{GND}=0.0 \mathrm{~V}, \\ & \mathrm{IAH}_{\mathrm{AH}}=500 \mu \mathrm{~A} \\ & \text { Digital data }=\# 00 \end{aligned}$ | Vss | - | Vss +0.2 | V |
| Output minimum voltage 4 | Vaol4 |  | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=\mathrm{V} \mathrm{VC}=3.0 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{SS}}=\mathrm{GND}=0.0 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{AL}}=1.0 \mathrm{~mA} \\ & \text { Digital data }=\# 00 \end{aligned}$ | Vss - 0.3 | Vss | Vss +0.3 | V |
| Output minimum voltage 5 | $V_{\text {AOL5 }}$ |  | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=\mathrm{V} \mathrm{VC}=3.0 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{SS}}=\mathrm{GND}=0.0 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{AH}}=1.0 \mathrm{~mA} \\ & \text { Digital data }=\# 00 \end{aligned}$ | Vss | - | Vss +0.3 | V |
| Output maximum voltage 1 | $V_{\text {AOH1 }}$ |  | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}, \\ & \mathrm{~V} \mathrm{Ss}=\mathrm{GND}=0.0 \mathrm{~V}, \\ & \mathrm{IAL}^{2}=0 \mu \mathrm{~A} \\ & \mathrm{Digital} \text { data }=\text { \#FF } \end{aligned}$ | Vdo - 0.1 | - | Vod | V |
| Output maximum voltage 2 | $\mathrm{V}_{\text {AOH2 }}$ |  | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=\mathrm{V} \mathrm{CC}=3.0 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{ss}}=\mathrm{GND}=0.0 \mathrm{~V}, \\ & \mathrm{IAL}^{2}=500 \mu \mathrm{~A} \\ & \text { Digital data }=\# \mathrm{FF} \end{aligned}$ | Vdo - 0.2 | - | Vod | V |
| Output maximum voltage 3 | $\mathrm{V}_{\text {Аонз }}$ |  | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{Ss}}=\mathrm{GND}=0.0 \mathrm{~V}, \\ & \mathrm{IAH}_{\mathrm{AH}}=500 \mu \mathrm{~A} \\ & \text { Digital data }=\# \mathrm{FF} \end{aligned}$ | Vdo - 0.2 | Vdo | $V_{\text {do }}+0.2$ | V |
| Output maximum voltage 4 | $\mathrm{V}_{\text {AOH4 }}$ |  | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=\mathrm{V} \mathrm{CC}=3.0 \mathrm{~V}, \\ & \mathrm{~V} \mathrm{Ss}=\mathrm{GND}=0.0 \mathrm{~V}, \\ & \mathrm{IAL}^{\mathrm{AL}} 1.0 \mathrm{~mA} \\ & \text { Digital data }=\# \mathrm{FF} \end{aligned}$ | Vdo - 0.3 | - | Vdo | V |
| Output maximum voltage 5 | $V_{\text {AOH5 }}$ |  | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=\mathrm{V}_{\mathrm{Cc}}=3.0 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{ss}}=\mathrm{GND}=0.0 \mathrm{~V}, \\ & \mathrm{IAH}^{\mathrm{AH}} 1.0 \mathrm{~mA} \\ & \text { Digital data }=\# \mathrm{FF} \end{aligned}$ | Vdo - 0.3 | Vod | Vod +0.3 | V |

## MB88346L

## 2. AC Characteristics

| $\left(\mathrm{V}\right.$ dd, $\mathrm{V}_{\mathrm{cc}}=2.7 \mathrm{~V}$ to 3.6 $\mathrm{V}(\mathrm{V} \mathrm{Cc} \geq \mathrm{V} \mathrm{Vd}), \mathrm{GND}=\mathrm{V} \mathrm{Ss}=0 \mathrm{~V}, \mathrm{Ta}=-20^{\circ} \mathrm{C}$ to $\left.+85{ }^{\circ} \mathrm{C}\right)$ |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Parameter | Symbol | Condition | Value |  | Unit |
|  |  |  | Min | Max |  |
| Clock L level pulse width | tckL | - | 200 | - | ns |
| Clock H level pulse width | tck | - | 200 | - | ns |
| Clock rise time Clock fall time | $\begin{aligned} & \text { tcr } \\ & \text { tcf } \end{aligned}$ | - | - | 200 | ns |
| Data setup time | toch | - | 30 | - | ns |
| Data hold time | tchd | - | 60 | - | ns |
| Load setup time | tchL | - | 200 | - | ns |
| Load hold time | tldc | - | 100 | - | ns |
| Load H level pulse width | tLDH | - | 100 | - | ns |
| Data output delay time | too | Refer to "• Load condition 1" | 70 | 600 | ns |
| D/A output settling time | tLDD | Refer to "• Load condition 2" | - | 300 | $\mu \mathrm{s}$ |

- Load condition 1

- Load condition 2



## MB88346L

- Input/output timing


Vao vs. IAO CHARACTERISTICS : EXAMPLE

(Continued)
(Continued)




## MB88346L

■ ORDERING INFORMATION

| Part number | Package | Remarks |
| :--- | :---: | :---: |
| MB88346LP | 20-pin plastic DIP <br> (DIP-20P-M02) |  |
| MB88346LPFV | 20-pin plastic SSOP <br> (FPT-20P-M03) |  |

## PACKAGE DIMENSIONS

| 20-pin plastic DIP | Lead pitch | $2.54 \mathrm{~mm}(100 \mathrm{mil})$ |
| :--- | :--- | :--- |
| Row spacing | $7.62 \mathrm{~mm}(300 \mathrm{mil})$ |  |
| Sealing method | Plastic mold |  |
| (DIP-20P-M02) |  |  |



Please confirm the latest Package dimension by following URL.
http://edevice.fujitsu.com/package/en-search/
(Continued)

## MB88346L

(Continued)

| 20-pin plastic SSOP | Lead pitch | 0.65 mm |
| :---: | :---: | :---: |
| Package width $\times$ <br> package length | $4.40 \times 6.50 \mathrm{~mm}$ |  |
| Lead shape | Gullwing |  |
| Sealing method | Plastic mold |  |
|  |  |  |



Please confirm the latest Package dimension by following URL. http://edevice.fujitsu.com/package/en-search/

MEMO

## MB88346L

MEMO

MEMO

## FUJITSU MICROELECTRONICS LIMITED

Shinjuku Dai-Ichi Seimei Bldg. 7-1, Nishishinjuku 2-chome, Shinjuku-ku, Tokyo 163-0722, Japan Tel: +81-3-5322-3347 Fax: +81-3-5322-3387 http://jp.fujitsu.com/fml/en/

For further information please contact:

North and South America<br>FUJITSU MICROELECTRONICS AMERICA, INC.<br>1250 E. Arques Avenue, M/S 333<br>Sunnyvale, CA 94085-5401, U.S.A.<br>Tel: +1-408-737-5600 Fax: +1-408-737-5999<br>http://www.fma.fujitsu.com/<br>\section*{Europe}<br>FUJITSU MICROELECTRONICS EUROPE GmbH<br>Pittlerstrasse 47, 63225 Langen,<br>Germany<br>Tel: +49-6103-690-0 Fax: +49-6103-690-122<br>http://emea.fujitsu.com/microelectronics/

## Korea

FUJITSU MICROELECTRONICS KOREA LTD.
206 KOSMO TOWER, 1002 Daechi-Dong,
Kangnam-Gu,Seoul 135-280
Korea
Tel: +82-2-3484-7100 Fax: +82-2-3484-7111
http://www.fmk.fujitsu.com/

Asia Pacific<br>FUJITSU MICROELECTRONICS ASIA PTE LTD.<br>151 Lorong Chuan, \#05-08 New Tech Park,<br>Singapore 556741<br>Tel: +65-6281-0770 Fax: +65-6281-0220<br>http://www.fujitsu.com/sg/services/micro/semiconductor/

FUJITSU MICROELECTRONICS SHANGHAI CO., LTD.
Rm.3102, Bund Center, No. 222 Yan An Road(E),
Shanghai 200002, China
Tel: +86-21-6335-1560 Fax: +86-21-6335-1605
http://cn.fujitsu.com/fmc/

FUJITSU MICROELECTRONICS PACIFIC ASIA LTD.
10/F., World Commerce Centre, 11 Canton Road
Tsimshatsui, Kowloon
Hong Kong
Tel: +852-2377-0226 Fax: +852-2376-3269
http://cn.fujitsu.com/fmc/tw

## All Rights Reserved.

The contents of this document are subject to change without notice.
Customers are advised to consult with sales representatives before ordering.
The information, such as descriptions of function and application circuit examples, in this document are presented solely for the purpose of reference to show examples of operations and uses of FUJITSU MICROELECTRONICS device; FUJITSU MICROELECTRONICS does not warrant proper operation of the device with respect to use based on such information. When you develop equipment incorporating the device based on such information, you must assume any responsibility arising out of such use of the information.
FUJITSU MICROELECTRONICS assumes no liability for any damages whatsoever arising out of the use of the information.
Any information in this document, including descriptions of function and schematic diagrams, shall not be construed as license of the use or exercise of any intellectual property right, such as patent right or copyright, or any other right of FUJITSU MICROELECTRONICS or any third party or does FUJITSU MICROELECTRONICS warrant non-infringement of any third-party's intellectual property right or other right by using such information. FUJITSU MICROELECTRONICS assumes no liability for any infringement of the intellectual property rights or other rights of third parties which would result from the use of information contained herein.
The products described in this document are designed, developed and manufactured as contemplated for general use, including without limitation, ordinary industrial use, general office use, personal use, and household use, but are not designed, developed and manufactured as contemplated (1) for use accompanying fatal risks or dangers that, unless extremely high safety is secured, could have a serious effect to the public, and could lead directly to death, personal injury, severe physical damage or other loss (i.e., nuclear reaction control in nuclear facility, aircraft flight control, air traffic control, mass transport control, medical life support system, missile launch control in weapon system), or (2) for use requiring extremely high reliability (i.e., submersible repeater and artificial satellite).
Please note that FUJITSU MICROELECTRONICS will not be liable against you and/or any third party for any claims or damages arising in connection with above-mentioned uses of the products.
Any semiconductor devices have an inherent chance of failure. You must protect against injury, damage or loss from such failures by incorporating safety design measures into your facility and equipment such as redundancy, fire protection, and prevention of over-current levels and other abnormal operating conditions.
Exportation/release of any products described in this document may require necessary procedures in accordance with the regulations of the Foreign Exchange and Foreign Trade Control Law of Japan and/or US export control laws.
The company names and brand names herein are the trademarks or registered trademarks of their respective owners.

